

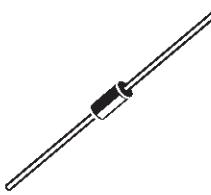
DIAC
FEATURES

- V_{BO} : 32V and 40V
- LOW BREAKOVER CURRENT

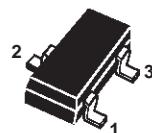
DESCRIPTION

Functioning as a trigger diode with a fixed voltage reference, the DB3/DB4 series can be used in conjunction with triacs for simplified gate control circuits or as a starting element in fluorescent lamp ballasts.

A new surface mount version is now available in SOT-23 package, providing reduced space and compatibility with automatic pick and place equipment.



**DO-35
(DB3 and DB4)**



**SOT-23
(SMDB3)***
Pin 1 and 3 must be shorted together

ABSOLUTE MAXIMUM RATINGS (limiting values)

Symbol	Parameter	Value	Unit
I _{TRM}	Repetitive peak on-state current tp = 20 µs F= 120 Hz	SMDB3	0.50
		DB3 / DB4	2.00
T _{stg} T _j	Storage temperature range Operating junction temperature range	- 40 to + 125	°C

Note: * SMDB3 indicated as Preliminary spec as product is still in development stage.

DB3 DB4 SMDB3

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions		SMDB3	DB3	DB4	Unit
V_{BO}	Breakover voltage *	$C = 22\text{nF}^{**}$	MIN.	28	28	35	V
			TYP.	32	32	40	
			MAX.	36	36	45	
$ V_{BO1} - V_{BO2} $	Breakover voltage symmetry	$C = 22\text{nF}^{**}$	MAX.	3			V
ΔV	Dynamic breakover voltage *	V_{BO} and V_F at 10mA	MIN.	10	5		V
V_O	Output voltage *	see diagram 2 ($R=20\Omega$)	MIN.	10	5		V
I_{BO}	Breakover current *	$C = 22\text{nF}^{**}$	MAX.	10	50		μA
t_r	Rise time *	see diagram 3	MAX.	0.50	2		μs
I_R	Leakage current *	$V_R = 0.5 V_{BO}$ max	MAX.	1	10		μA
I_P	Peak current *	see diagram 2 (Gate)	MIN.	0.50	0.30		A

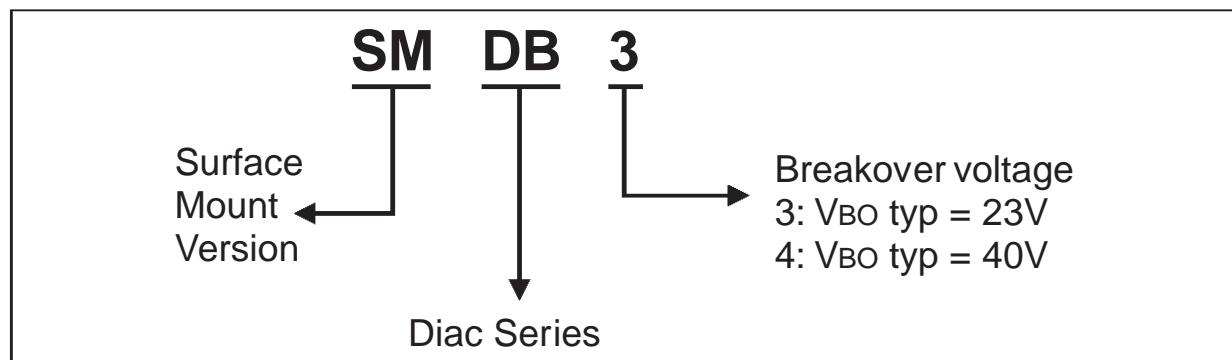
* Applicable to both forward and reverse directions.

** Connected in parallel to the device.

PRODUCT SELECTOR

Part Number	V_{BO}	Package
SMDB3	28 - 36	SOT-23
DB3	28 - 36	DO-35
DB4	35 - 45	DO-35

ORDERING INFORMATION



OTHER INFORMATION

Part Number	Marking	Weight	Base Quantity	Packing Mode
SMDB3	DB3	0.01 g	3000	Tape & Reel
DB3	DB3 (Blue Body Coat)	0.15 g	5000	Tape & Reel
DB4	DB4 (Blue Body Coat)	0.15 g	5000	Tape & Reel

Diagram 1: Voltage - current characteristic curve.

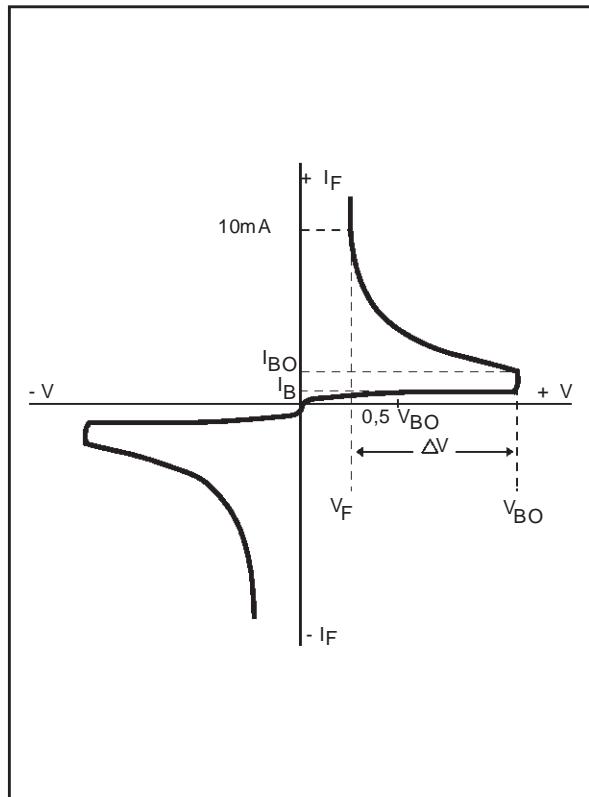


Diagram 2: Test circuit.

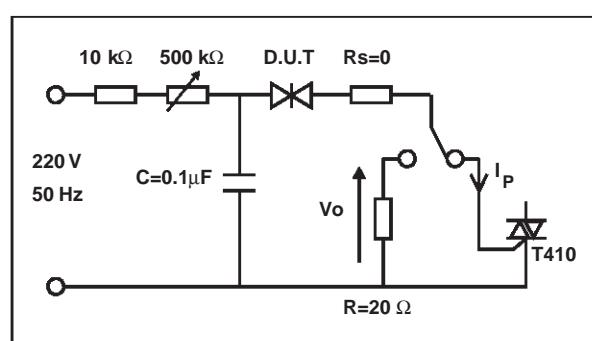
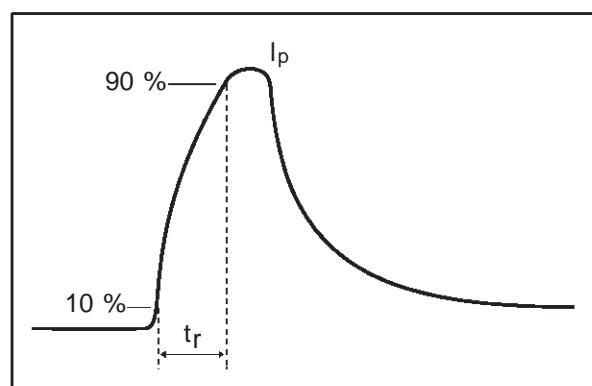


Diagram 3: Rise time measurement.



DB3 DB4 SMDB3

Fig. 1: Relative variation of VBO versus junction temperature (typical values).

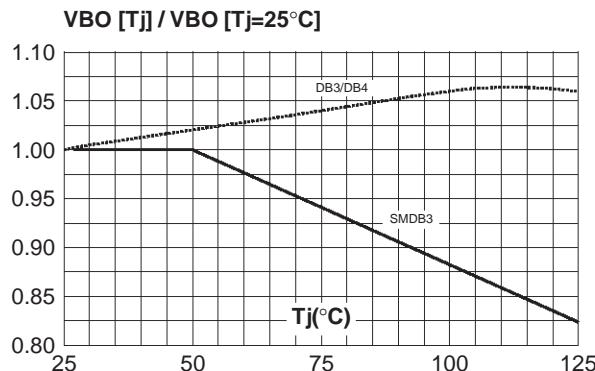


Fig. 2: Repetitive peak pulse current versus pulse duration (maximum values).

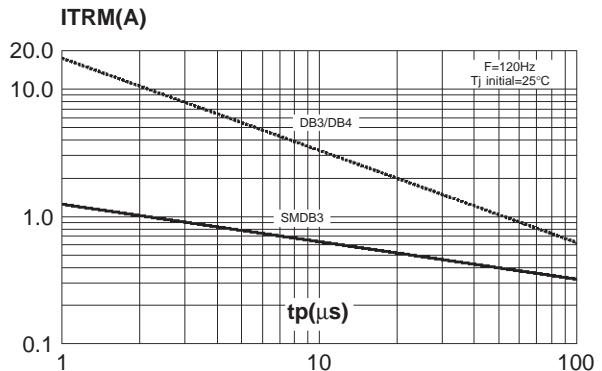
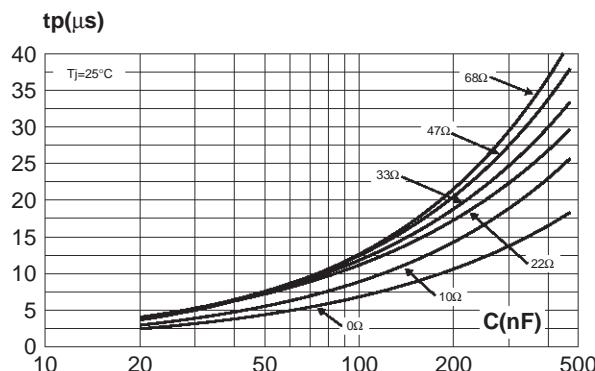


Fig. 3: Time duration while current pulse is higher than 50mA versus C and R_s (typical values).



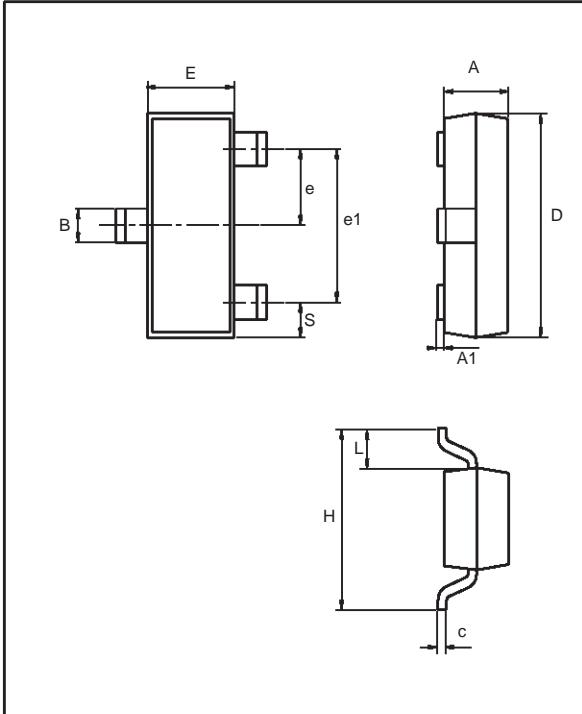
PACKAGE MECHANICAL DATA (in millimeters) DO-35

The mechanical drawing shows a top-down view of the DO-35 package. It features a central rectangular body with two leads extending from the bottom. Dimension A is the width of the central body, C is the distance between the centers of the leads, and B is the height of the central body. Lead diameter is labeled as ϕD , and the total lead width is labeled as ϕB .

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	3.05	4.50	0.120	0.177
B	1.53	2.00	0.060	0.079
C	12.7		0.500	
D	0.458	0.558	0.018	0.022

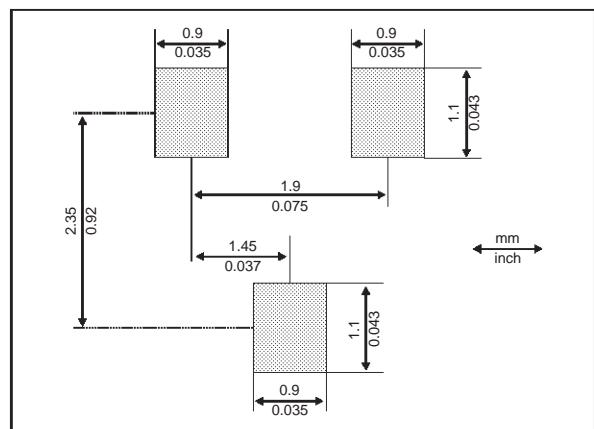
PACKAGE MECHANICAL DATA (in millimeters)

SOT-23



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.89	1.4	0.035	0.055
A1	0	0.1	0	0.004
B	0.3	0.51	0.012	0.02
C	0.085	0.18	0.003	0.007
D	2.75	3.04	0.108	0.12
e	0.85	1.05	0.033	0.041
e1	1.7	2.1	0.067	0.083
E	1.2	1.6	0.047	0.063
H	2.1	2.75	0.083	0.108
L	0.6 typ.		0.024 typ.	
S	0.35	0.65	0.014	0.026

FOOTPRINT



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